

Stanford ENGINEERING

Aeronautics & Astronautics

tjiang@stu.edu.cn

243 Daxue Road, Shantou, Guangdong

Dear **Tao Jiang**,

This letter is in support of your visa application to attend the 14th International Workshop on Structural Health Monitoring to be held at Stanford University from September 12th to September 14th, 2023. We look forward to your attendance and presentation of your paper entitled **A new method for shape sensing of structural large deformations**. Your attendance is important for the success of this workshop.

The theme of 14th IWSHM is "Designing SHM for Sustainability, Maintainability, and Reliability". The objectives of the Workshop are to review the progress of the current rapid development in the technologies related to the SHM field, identify key and emerging issues in research and development, and promote exchanges and cross-fertilization across many disciplines including networks, computing, data mining, diagnostics, prognostics and multifunctional materials, and their applications in fields ranging from ground/air/space transportation vehicles, mechanical and machinery systems, civil infrastructures and marine structures.

On behalf of the organizing committee, we look forward to seeing you in the IWSHM event at Stanford this coming September 2023. Please let our organizing committee know if you need any assistance in arranging your trip.

Sincerely,



Dr. Fu-Kuo Chang

Professor

Department of Aeronautics & Astronautics

Stanford University

(650) 723-3466 | fkchang@stanford.edu